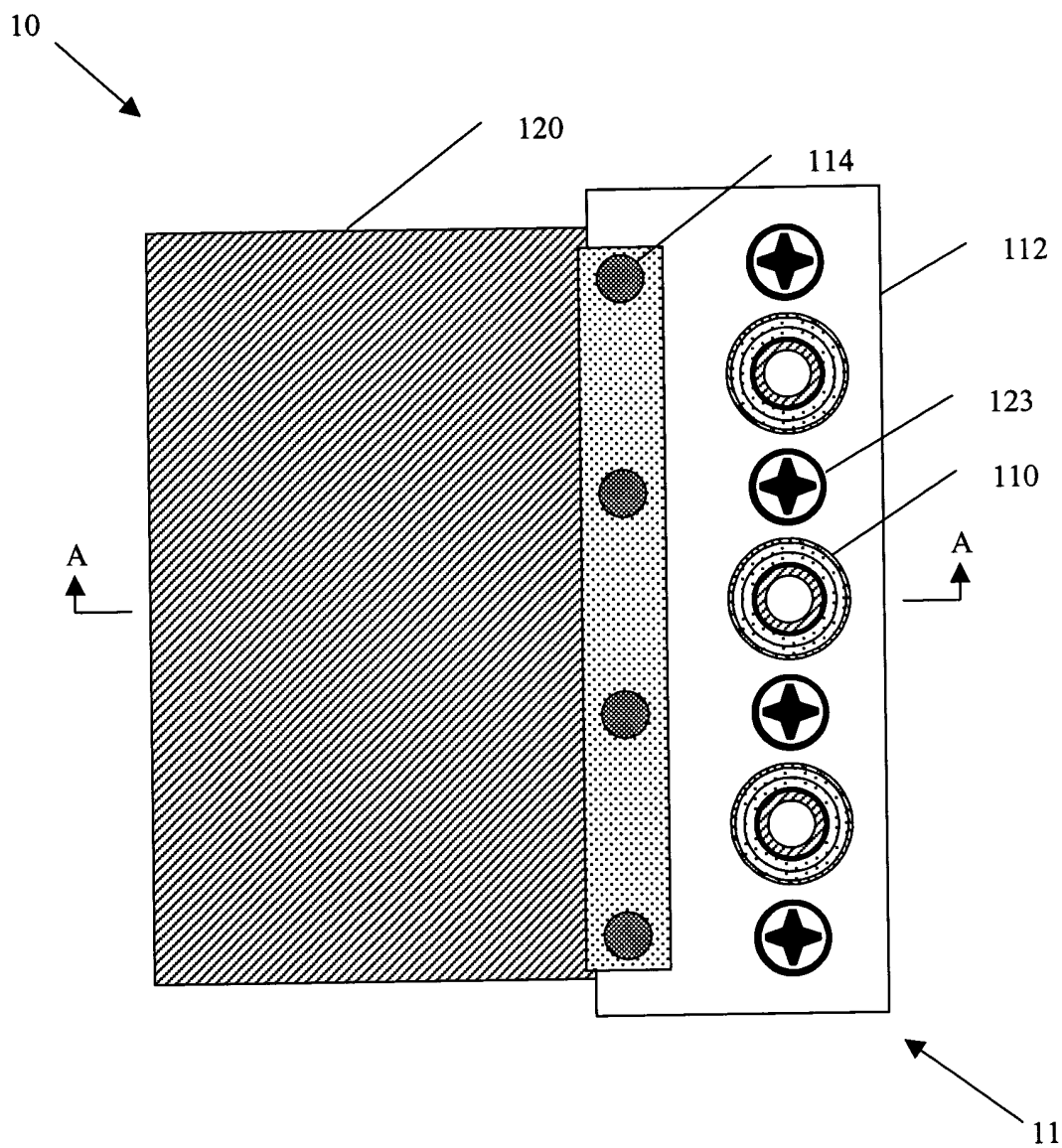
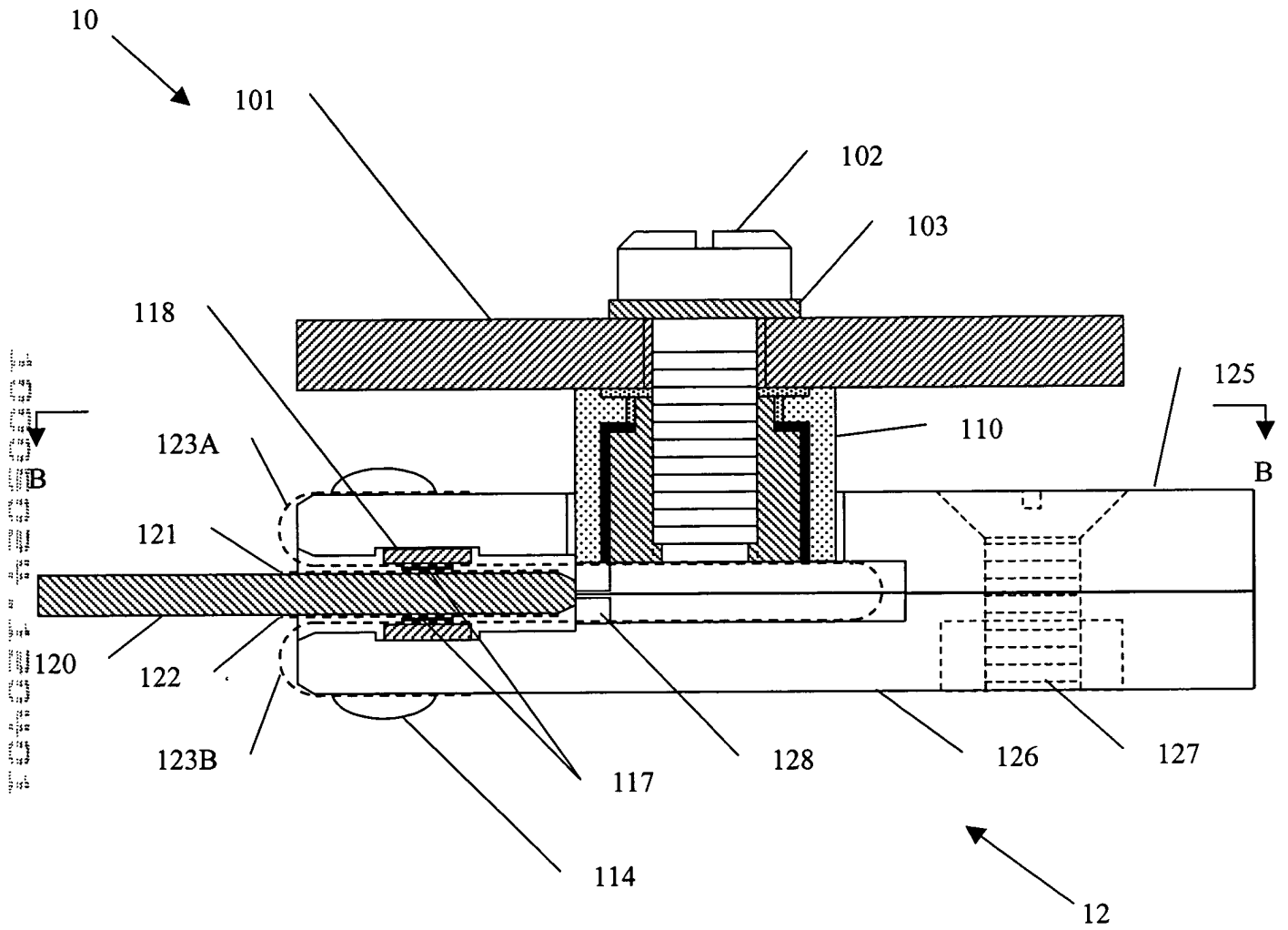


Section A-A
FIG. 1A

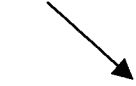


Section B-B
FIG. 1B



Section A-A
 FIG. 2A

10



120

114

125

A



127

110

A

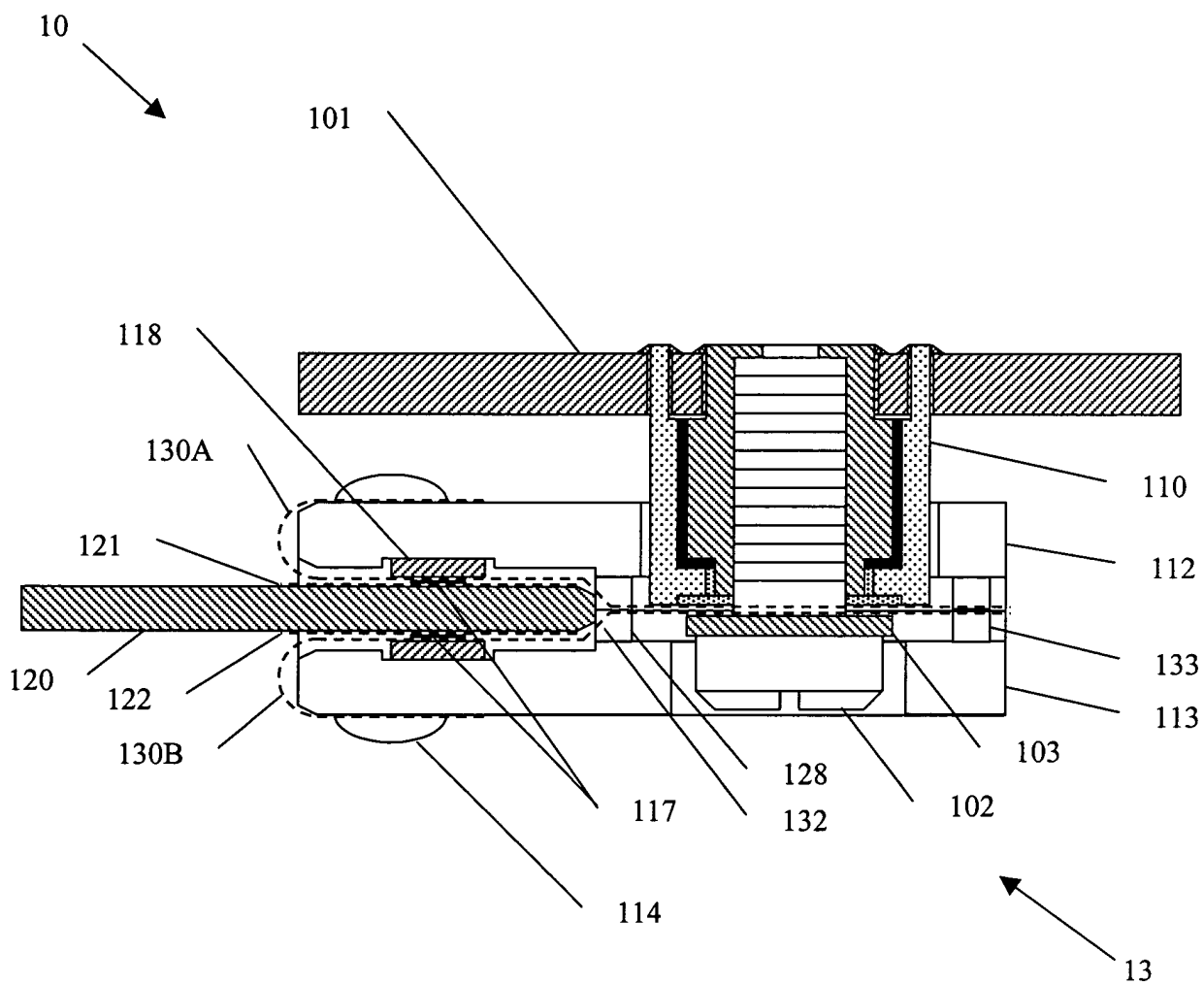


12

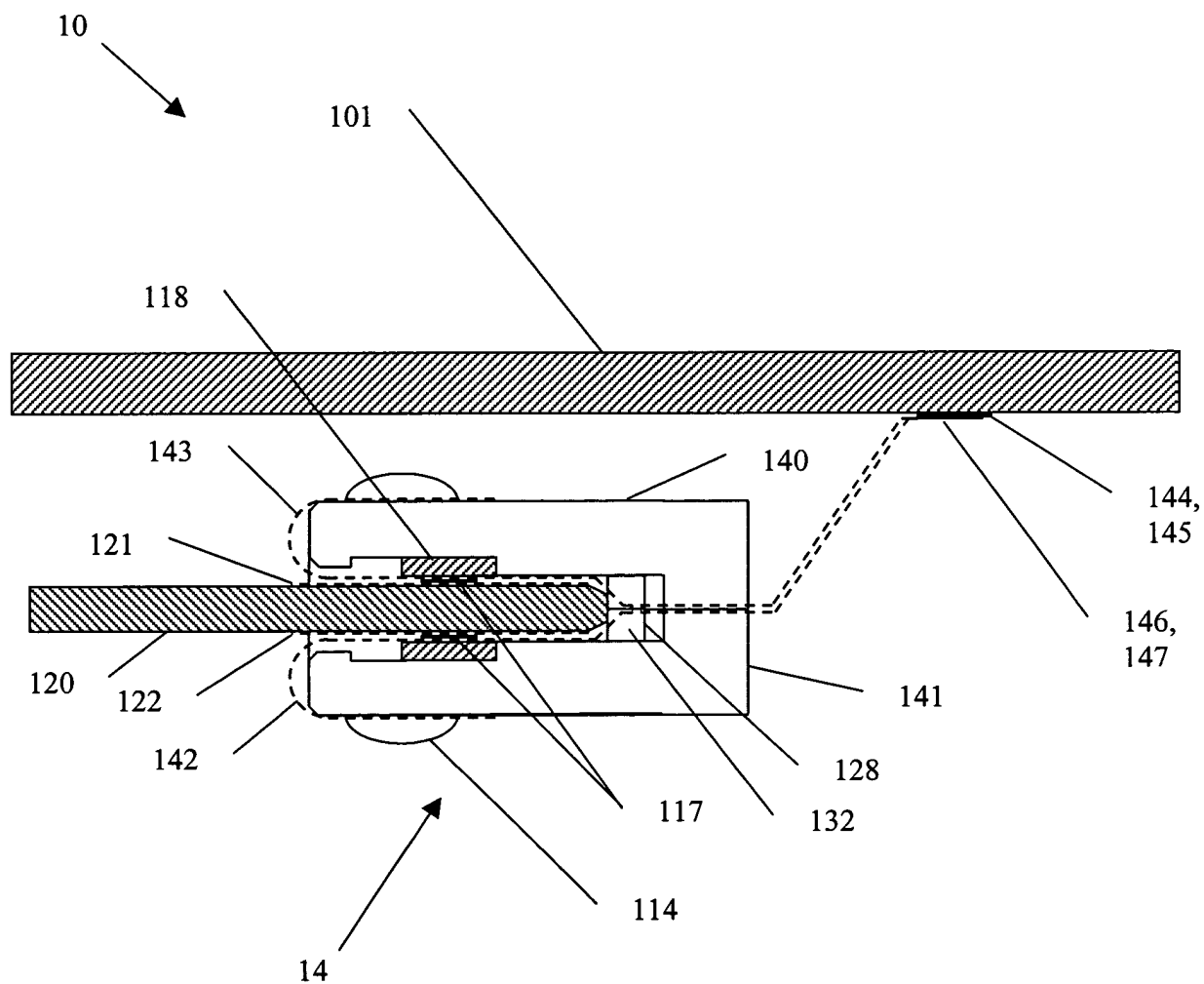


Section B-B
FIG. 2B

FIG. 2B is a cross-sectional view of the device 10 taken along line A-A of FIG. 1. The device 10 includes a substrate 110 and a layer 114 disposed on the substrate 110. The layer 114 includes a plurality of openings 120. The openings 120 are formed in the layer 114 and extend through the layer 114. The openings 120 are formed in the layer 114 and extend through the layer 114. The openings 120 are formed in the layer 114 and extend through the layer 114.



Section A-A
FIG. 3



Section A-A
FIG. 4A

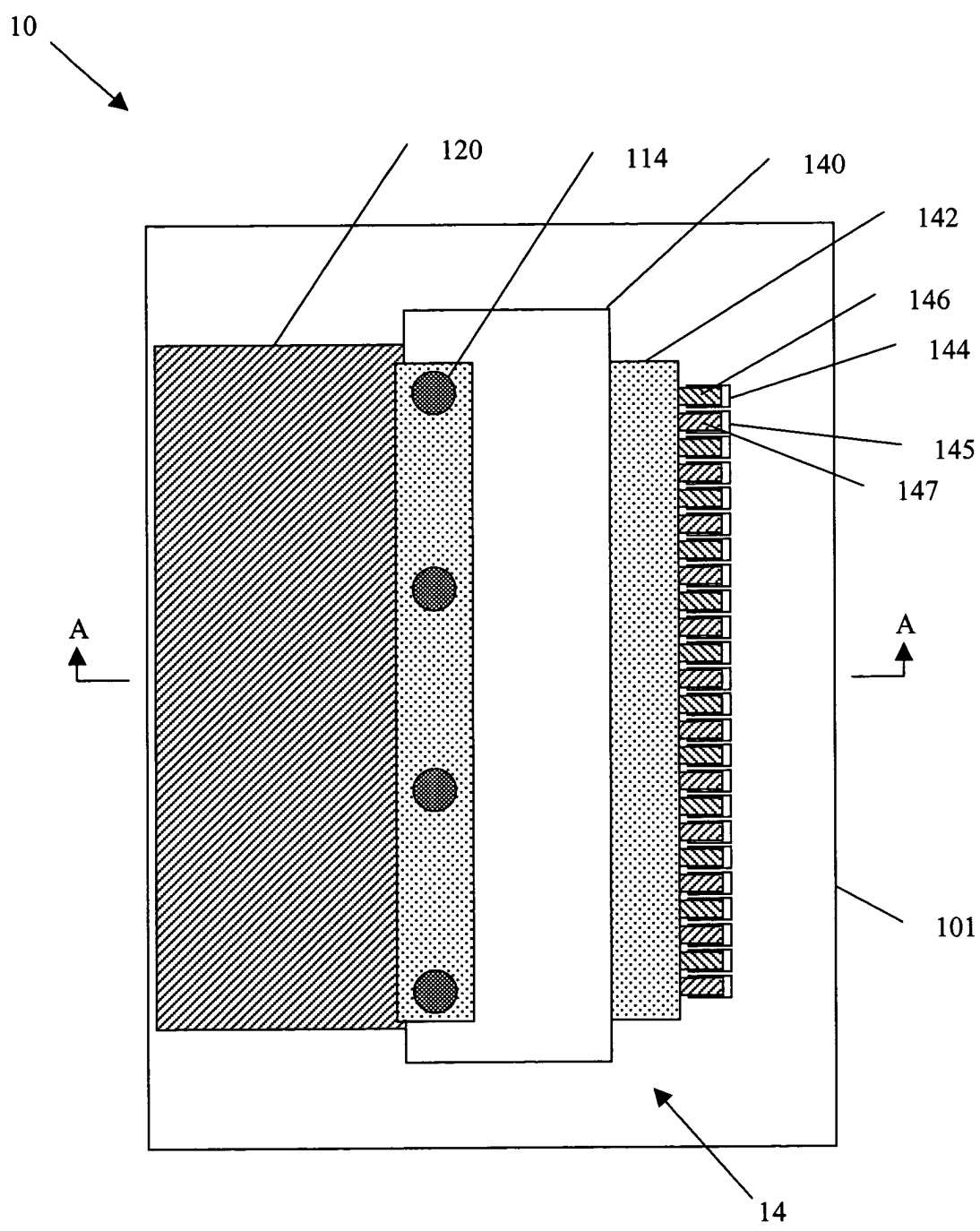


FIG. 4B

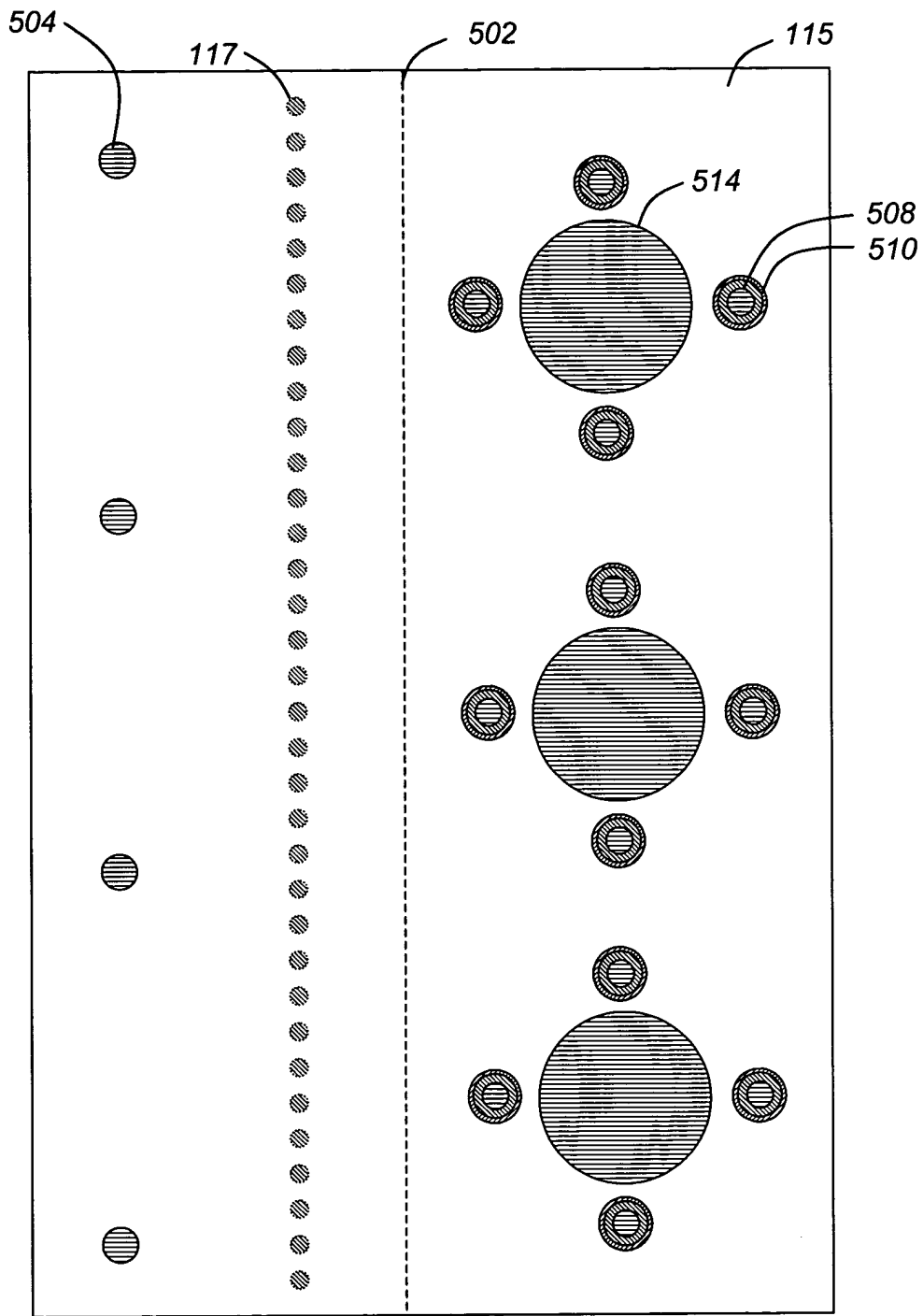


FIG. 5A

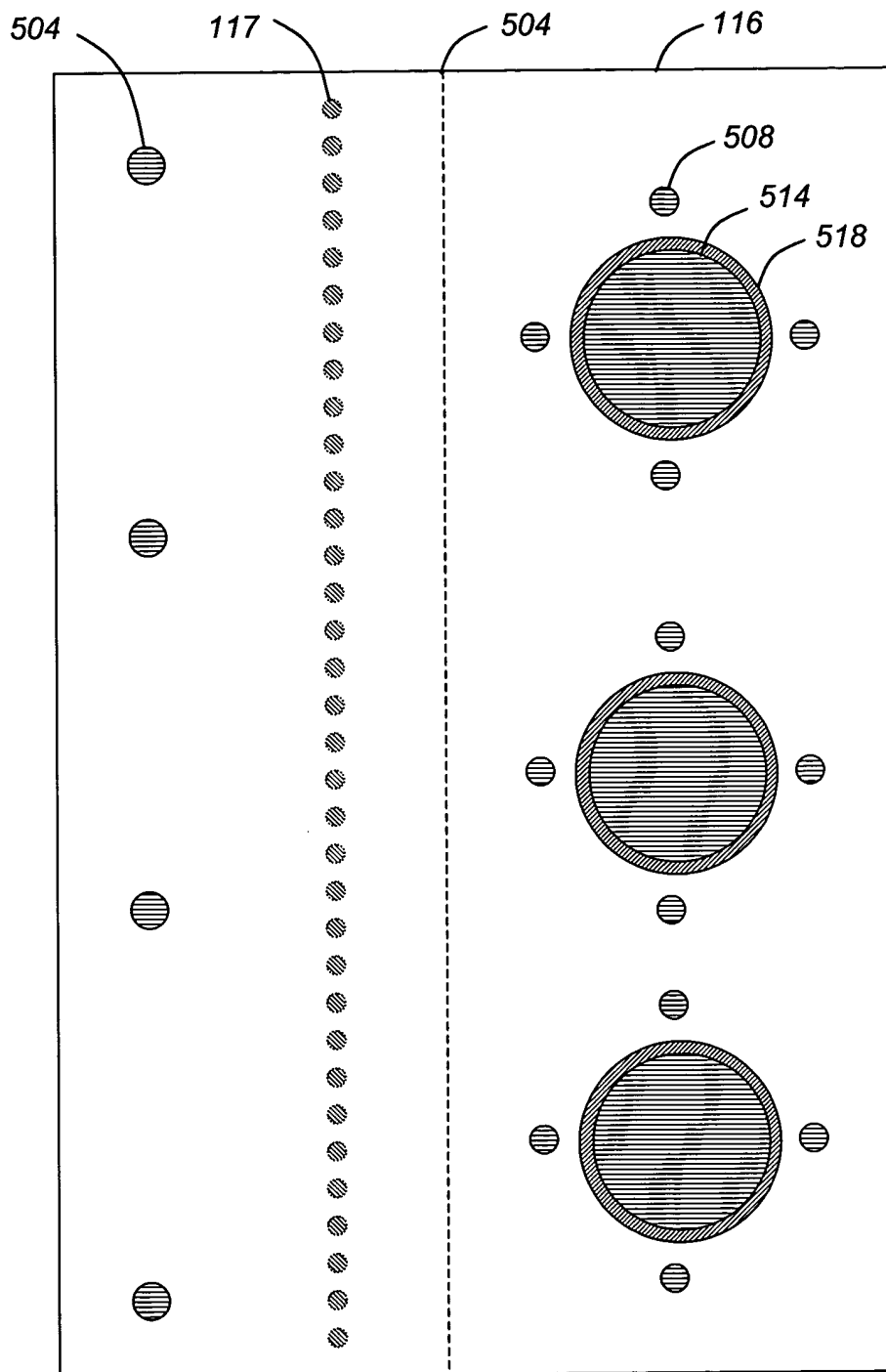


FIG. 5B